SEMICONDUCTOR

MM74HC597 8-Bit Shift Registers with Input Latches

General Description

FAIRCHILD

This high speed register utilizes advanced silicon-gate CMOS technology. It has the high noise immunity and low power consumption of standard CMOS integrated circuits, as well as the ability to drive 10 LS-TTL loads.

The MM74HC597 comes in a 16-pin package and consists of an 8-bit storage latch feeding a parallel-in, serial-out 8-bit shift register. Both the storage register and shift register have positive-edge triggered clocks. the shift register also has direct load (from storage) and clear inputs.

The 74HC logic family is speed, function, and pin-out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to $V_{\mbox{\scriptsize CC}}$ and ground.

Features

- 8-bit parallel storage register inputs
- Wide operating voltage range: 2V–6V
- Shift register has direct overriding load and clear

January 1988

Revised August 2000

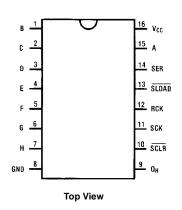
- Guaranteed shift frequency: DC to 30 MHz
- Low quiescent current: 80 μA maximum

Ordering Code:

Order Number	Package Number	Package Description
MM74HC597M	M16A	16-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-012, 0.150 Narrow
MM74HC597SJ	M16D	16-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
MM74HC597N	N16E	16-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Connection Diagram

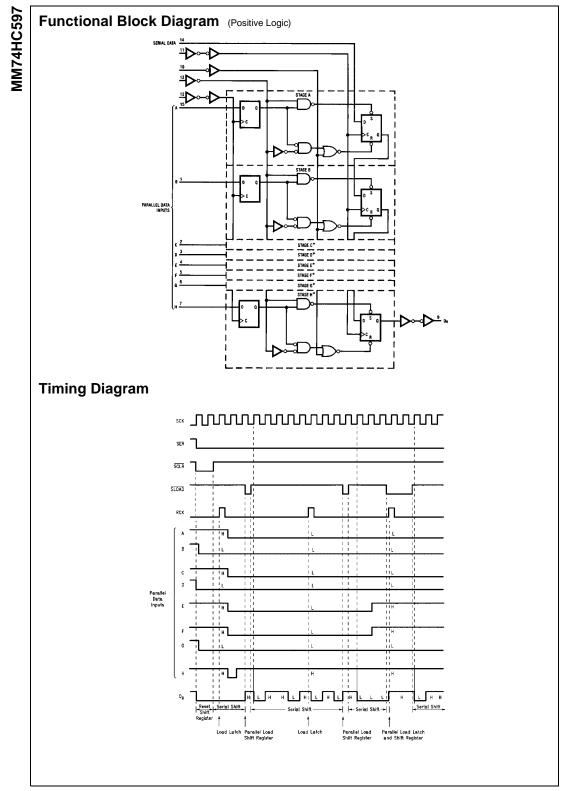


RCK	SCK	SLOAD	SCLR
Ŷ	Х	Х	Х

Truth Table

RCK	SCK	SLOAD	SCLR	Function
↑	Х	Х	Х	Data Loaded to input latches
\uparrow	х	1	н	Data loaded from inputs to
	^	L		shift register
No				Data transferred from
clock	Х	L	н	input latches to shift
edge				register
				Invalid logic, state of
Х	Х	L	L	shift register indeterminate
				when signals removed
Х	Х	Н	L	Shift register cleared
х	\uparrow	н	н	Shift register clocked
^	1		11	$Q_n = Q_n - 1, Q_0 = SER$

© 2000 Fairchild Semiconductor Corporation DS005343 www.fairchildsemi.com



Absolute Maximum Ratings(Note 1)

(Note 2)

Recommended Operating Conditions

(
Supply Voltage (V _{CC})	-0.5 to +7.0V
DC Input Voltage (V _{IN})	–1.5 to $V_{CC}\text{+}1.5\text{V}$
DC Output Voltage (V _{OUT})	–0.5 to $V_{CC}\mbox{+}0.5\mbox{V}$
Clamp Diode Current (I _{IK} , I _{OK})	±20 mA
DC Output Current, per pin (I _{OUT})	±25 mA
DC V_{CC} or GND Current, per pin (I _{CC})	±70 mA
Storage Temperature Range (T _{STG})	$-65^{\circ}C$ to $+150^{\circ}C$
Power Dissipation (P _D)	
(Note 3)	600 mW
S.O. Package only	500 mW
Lead Temperature (T _L)	
(Soldering 10 seconds)	260°C

	Min	Max	Units
Supply Voltage (V _{CC})	2	6	V
DC Input or Output Voltage			
(V _{IN} , V _{OUT})	0	V _{CC}	V
Operating Temperature Range (T _A)	-40	+85	°C
Input Rise or Fall Times			
$(t_r, t_f) V_{CC} = 2.0 V$		1000	ns
$V_{CC} = 4.5V$		500	ns
$V_{CC} = 6.0V$		400	ns
Note 1: Absolute Maximum Ratings are those age to the device may occur.	values be	eyond whi	ch dam-

Note 2: Unless otherwise specified all voltages are referenced to ground.

Note 3: Power Dissipation temperature derating — plastic "N" package: – 12 mW/°C from 65°C to 85°C.

Symbol	Parameter	Conditions	v _{cc}	$T_A = 25^{\circ}C$		$T_A{=}{-}40$ to $85^\circ C$	$T_A = -55$ to $125^\circ C$	Units
Symbol	Farameter	Conditions	• CC	Тур		Guaranteed L	imits	onito
V _{IH}	Minimum HIGH Level		2.0V		1.5	1.5	1.5	
	Input Voltage		4.5V		3.15	3.15	3.15	V
			6.0V		4.2	4.2	4.2	
V _{IL}	Maximum LOW Level		2.0V		0.5	0.5	0.5	
	Input Voltage		4.5V		1.35	1.35	1.35	V
	(Note 5)		6.0V		1.8	1.8	1.8	
V _{OH}	Minimum HIGH Level	$V_{IN} = V_{IH}$ or V_{IL}						
	Output Voltage	I _{OUT} ≤ 20 μA	2.0V	2.0	1.9	1.9	1.9	v
			4.5V	4.5	4.4	4.4	4.4	v
			6.0V	6.0	5.9	5.9	5.9	
		$V_{IN} = V_{IH}$ or V_{IL}						
		$ I_{OUT} \le 4.0 \text{ mA}$	4.5V	4.2	3.98	3.84	3.7	V
		I _{OUT} ≤ 5.2 mA	6.0V	5.2	5.48	5.34	5.2	
V _{OL}	Maximum LOW Level	$V_{IN} = V_{IH}$ or V_{IL}						
	Output Voltage	I _{OUT} ≤ 20 μA	2.0V	0	0.1	0.1	0.1	v
			4.5V	0	0.1	0.1	0.1	v
			6.0V	0	0.1	0.1	0.1	
		$V_{IN} = V_{IH} \text{ or } V_{IL}$						
		I _{OUT} ≤ 4 mA	4.5V	0.2	0.26	0.33	0.4	V
		$ I_{OUT} \le 5.2 \text{ mA}$	6.0V	0.2	0.26	0.33	0.4	
I _{IN}	Maximum Input Current	$V_{IN} = V_{CC}$ or GND	6.0V		±0.1	±1.0	±1.0	μΑ
ICC	Maximum Quiescent Supply Current	V _{IN} = V _{CC} or GND I _{OUT} = 0 μA	6.0V		8.0	80	160	μΑ

DC Electrical Characteristics (Note 4)

Note 4: For a power supply of 5V \pm 10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5V. Thus the 4.5V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5V and 4.5V respectively. (The V_{IH} value at 5.5V is 3.85V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{O2}) occur for CMOS at the higher voltage and so the 6.0V values should be used.

Note 5: V_{IL} limits are currently tested at 20% of V_{CC} . The above V_{IL} specification (30% of V_{CC}) will be implemented no later than Q1, CY'89.

Symbol	Parameter		Cond	itions		Тур	Guarantee Limit	d U	nits
f _{MAX}	Maximum Operating					50	30	N	1Hz
t _{PHL}	Frequency of SCK Maximum Propagation								
t _{PLH}	Delay from SCK to Q _H					20	30		ns
t _{PHL}	Maximum Propagation					20	30		ns
t _{PLH}	Delay from SLOAD to Q _H					20	50		113
t _{PHL}	Maximum propagation	SLC	DAD = logic "0"			25	45		ns
t _{PLH}	Delay from RCK to Q _H Maximum Propagation								
t _{PHL}	Delay from $\overline{\text{SCLR}}$ to Q_H					20	30		ns
t _{REM}	Minimum Removal Time,					10	20		20
	SCLR to SCK					10	20		ns
t _S	Minimum Setup Time					30	40		ns
to	from RCK to SCK Minimum Setup Time							_	
t _S	from SER to SCK					10	20		ns
t _S	Minimum Setup Time								
	from inputs A thru H					10	20	1	ns
	to RCK								
t _H	Minimum Hold Time Minimum Pulse Width					-2	0	-	ns
t _W	SCK, RCK, SCLR SLOAD					10	16		ns
AC EI	ectrical Charact	teristics Conditio		T _A =	pF, t _r = t _f = 25°C	T _A =-40 to	o 85°C T _A =–5		
Symbol	Parameter		ns V _{CC}	T _A = Typ	25°C	T _A =-40 to Guarant	o 85°C T _A =-5 teed Limits	i5 to 125°C	
				T _A =		T _A =-40 to	o 85°C T _A =–5 teed Limits		;
Symbol	Parameter Maximum Operating		v _{cc} 2.0V	Т _А = Тур 10	25°C	T _A =-40 to Guarant 4.8	o 85°C T _A =–5 teed Limits	55 to 125°C 4.0	;
Symbol f _{MAX}	Parameter Maximum Operating Frequency Maximum Propagation		No. V _{CC} 2.0V 4.5V 6.0V 2.0V	T _A = Typ 10 45 50 62	25°C 6.0 30 35 175	T _A =-40 to Guarant 4.8 24 28 220	o 85°C T _A =-5 teed Limits	4.0 20 24 263	;
Symbol f _{MAX}	Parameter Maximum Operating Frequency		No. V _{CC} 2.0V 4.5V 6.0V 2.0V 4.5V 4.5V	T _A = Typ 10 45 50 62 20	25°C 6.0 30 35 175 35	T _A =-40 to Guarant 4.8 24 28 220 44	o 85°C T _A =-5 teed Limits	4.0 20 24 263 53	;
Symbol f _{MAX} t _{PHL} t _{PLH}	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H		ns V _{CC} 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V	T _A = Typ 10 45 50 62 20 18	25°C 6.0 30 35 175 35 30	T _A =-40 tr Guarant 4.8 24 28 220 44 38	teed Limits	4.0 20 24 263 53 45	;
Symbol f _{MAX}	Parameter Maximum Operating Frequency Maximum Propagation		No. V _{CC} 2.0V 4.5V 6.0V 2.0V 4.5V 4.5V	T _A = Typ 10 45 50 62 20	25°C 6.0 30 35 175 35	T _A =-40 to Guarant 4.8 24 28 220 44	D 85°C T _A =-5 teed Limits	4.0 20 24 263 53	;
Symbol f _{MAX} t _{PHL} t _{PHL}	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation		ns V _{CC} 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V 2.0V	T _A = Typ 10 45 50 62 20 18 65	25°C 6.0 30 35 175 35 30 175	T _A =-40 tr Guarant 4.8 24 28 220 44 38 220	D 85°C T _A =-5 teed Limits	4.0 20 24 263 53 45 263	;
Symbol f _{MAX} t _{PHL} t _{PHL}	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation Delay from SLOAD to Q _H Maximum Propagation	Conditio	ns V _{CC} 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V 2.0V	T _A = Typ 10 45 50 62 20 18 65 20 18 10 120	25°C 6.0 30 35 175 35 30 175 35 30 205	T _A =-40 to Guarant 4.8 24 28 220 44 38 220 44 38 220 44 38 220 44 38 255	D 85°C T _A =-5 teed Limits	4.0 20 24 263 53 45 263 53 45 263 53 45 310	;
Symbol f _{MAX} t _{PHL} t _{PLH} t _{PHL} t _{PLH}	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation Delay from SLOAD to Q _H		ns V _{CC} 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V 2.0V	T _A = Typ 10 45 50 62 20 18 65 20 18 65 20 30	25°C 6.0 30 35 175 35 30 175 35 30 205 41	T _A =-40 to Guarant 4.8 24 28 220 44 38 220 44 38 220 44 38 220 51	D 85°C T _A =-5 iteed Limits	4.0 20 24 263 53 45 263 53 45 263 53 45 310 62	;
Symbol f _{MAX} t _{PHL} t _{PLH} t _{PHL} t _{PLH} t _{PLH} t _{PLH}	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation Delay from SLOAD to Q _H Maximum Propagation Delay from SLOAD to Q _H Maximum Propagation Delay from SLOAD to Q _H	Conditio	ns V _{CC} 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V 4.5V 6.0V	T _A = Typ 10 45 50 62 20 18 65 20 18 65 20 18 20 28	25°C 6.0 30 35 175 35 30 175 35 30 205 41 35	T _A =-40 to Guarant 4.8 24 28 220 44 38 220 44 38 220 44 38 255 51 43	D 85°C T _A =-5 iteed Limits	4.0 20 24 263 53 45 263 53 45 310 62 53	;
Symbol f _{MAX} t _{PHL} t _{PHL} t _{PHL} t _{PHL} t _{PHL} t _{PHL}	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation Delay from SLOAD to Q _H Maximum Propagation	Conditio	ns V _{CC} 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V 2.0V 4.5V 6.0V 2.0V	T _A = Typ 10 45 50 62 20 18 65 20 18 65 20 30	25°C 6.0 30 35 175 35 30 175 35 30 205 41	T _A =-40 to Guarant 4.8 24 28 220 44 38 220 44 38 220 44 38 220 51	D 85°C T _A =-5 iteed Limits	4.0 20 24 263 53 45 263 53 45 263 53 45 310 62	;
Symbol f _{MAX} t _{PHL} t _{PLH} t _{PHL} t _{PLH} t _{PLH} t _{PLH}	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation Delay from SLOAD to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagation Delay from RCK to Q _H Delay from RCK to Q _H Maximum Propagatin Delay from SCLR to Q _H	Conditio	ns V _{CC} 2.0V 4.5V 6.0V 4.5V 6.0V 2.0V 4.5V 6.0V 4.5V 6.0V 4.5V 6.0V 4.5V 6.0V 4.5V 6.0V 4.5V 6.0V 4.5V 6.0V 4.5V 6.0V 4.5V 6.0V 4.5V 6.0V 4.5V 6.0V 4.5V 6.0V 4.5V 6.0V 4.5V 6.0V	T _A = Typ 10 45 50 62 20 18 65 20 18 65 20 18 65 20 28 66	25°C 6.0 30 35 175 35 30 175 35 30 205 41 35 30 205 41 35 30	T _A =-40 to Guaranti 4.8 24 28 220 44 38 220 44 38 255 51 43 220 44 38 255 51 43 38	o 85°C T _A =-5 teed Limits ;)	4.0 20 24 263 53 45 263 53 45 310 62 53 263 53 45 310 62 53 263 53 45	;
Symbol f _{MAX} t _{PHL} t _{PLH} t _{PHL} t _{PLH} t _{PLH} t _{PLH}	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation Delay from SLOAD to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagatin Delay from SCLR to Q _H Minimum Removal Time	Conditio	ns Vcc 2.0V 4.5V 6.0V	T _A = Typ 10 45 50 62 20 18 65 20 18 65 20 18 65 20 20 18 65 20 18 66 20	25°C 6.0 30 35 175 35 30 175 35 30 205 41 35 30 205 41 35 30 100	T _A =-40 to Guaranti 4.8 24 280 44 38 2200 44 38 255 51 43 2200 44 38 255 51 43 2200 44 38 2200 44 38 2200 44 38 2100	o 85°C T _A =-5 teed Limits	4.0 20 24 263 53 45 263 53 45 310 62 53 45 263 53 45 310 62 53 45 53 45 53 45 150	;
Symbol f _{MAX} t _{PHL} t _{PLH} t _{PHL} t _{PLH} t _{PHL} t _{PLH} t _{PLH} t _{PLH}	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation Delay from SLOAD to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagation Delay from RCK to Q _H Delay from RCK to Q _H Maximum Propagatin Delay from SCLR to Q _H	Conditio	ns Vcc 2.0V 4.5V 6.0V 4.5V 6.0V 4.5V	T _A = Typ 10 45 50 62 20 18 65 20 18 65 20 18 65 20 20 18 65 20 18 66 20	25°C 6.0 30 35 175 35 30 175 35 30 205 41 35 30 205 41 35 30 100 20	T _A =-40 to Guarant 4.8 24 28 220 44 38 2255 51 43 220 44 38 255 51 43 220 44 38 2255 51 43 220 44 38 220 44 38 220 42 38 220 44 38 220 44 38 220 44 38 220 44 38 220 42 38 255	o 85°C T _A =-5 teed Limits	is to 125°C 4.0 20 24 263 53 45 310 62 53 45 263 53 45 310 62 53 45 30	;
Symbol f _{MAX} tPHL	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation Delay from SLOAD to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagatin Delay from SCLR to Q _H Minimum Removal Time	Conditio	ns Vcc 2.0V 4.5V 6.0V	T _A = Typ 10 45 50 62 20 18 65 20 18 65 20 18 65 20 20 18 65 20 18 66 20	25°C 6.0 30 35 175 35 30 175 35 30 205 41 35 30 205 41 35 30 100	T _A =-40 to Guaranti 4.8 24 280 44 38 2200 44 38 255 51 43 2200 44 38 255 51 43 2200 44 38 2200 44 38 2200 44 38 2100	o 85°C T _A =-5 teed Limits	4.0 20 24 263 53 45 263 53 45 310 62 53 45 263 53 45 310 62 53 45 53 45 53 45 150	
Symbol f _{MAX} t _{PHL} t _{PLH} t _{PHL} t _{PLH} t _{PHL} t _{PLH} t _{PLH} t _{PLH}	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation Delay from SLOAD to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagatin Delay from SCLR to Q _H Minimum Removal Time SCLR to SCK	Conditio	ns Vcc 2.0V 4.5V 6.0V 6.0V 2.0V 4.5V 6.0V	T _A = Typ 10 45 50 62 20 18 65 20 18 65 20 18 65 20 20 18 65 20 18 66 20	25°C 6.0 30 35 175 35 30 175 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 100 20 17	T _A =-40 to Guarant 4.8 24 28 220 44 38 220 44 38 2255 51 43 2200 44 38 2255 51 43 2200 44 38 2200 44 38 2200 24 38 2200 24 38 2200 244 38 2200 244 38 2200 2200 244 38 2200 244 38 2200 221	o 85°C T _A =-5 teed Limits	is to 125°C 4.0 20 24 263 53 45 310 62 53 45 310 62 53 45 310 62 53 45 30 25	;
Symbol f _{MAX} tPHL	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation Delay from SLOAD to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagatin Delay from SCLR to Q _H Minimum Removal Time SCLR to SCK Minimum Setup Time from RCK to SCK	Conditio	ns Vcc 2.0V 4.5V 6.0V 4.5V 6.0V 6.0V 4.5V 6.0V 6.0V 6.0V 6.0V 6.0V 6.0V	T _A = Typ 10 45 50 62 20 18 65 20 18 65 20 18 65 20 28 66 20	25°C 6.0 30 35 175 35 30 175 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 30 32 35 30 35 30 35 30 35 35 35 30 35 35 35 30 35 35 35 35 35 35 35 35 35 35 35 35 35	T _A =-40 to Guarant 4.8 24 28 220 44 38 225 51 43 220 44 38 225 51 43 220 44 38 220 44 38 225 51 43 525 21 255 21 250 50 42	o 85°C T _A =-5 iteed Limits	is to 125°C 4.0 20 24 263 53 45 263 53 45 310 62 53 45 150 30 25 300 60 50	
Symbol f _{MAX} tPHL	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation Delay from SLOAD to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagatin Delay from SCLR to Q _H Minimum Removal Time SCLR to SCK Minimum Setup Time from RCK to SCK Minimum Setup Time	Conditio	ns Vcc 2.0V 4.5V 6.0V	T _A = Typ 10 45 50 62 20 18 65 20 18 65 20 18 65 20 28 66 20	25°C 6.0 30 35 175 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 205 205 41 35 30 205 205 41 205 205 205 205 205 205 205 205 205 205	T _A =-40 to Guarant 4.8 24 28 220 44 38 225 51 43 220 44 38 225 51 43 220 44 38 225 21 255 21 250 50 42 125	o 85°C T _A =-5 iteed Limits	is to 125°C 4.0 20 24 263 53 45 263 53 45 310 62 53 45 150 300 60 50 150	
Symbol f _{MAX} tPHL tREM	Parameter Maximum Operating Frequency Maximum Propagation Delay from SCK to Q _H Maximum Propagation Delay from SLOAD to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagation Delay from RCK to Q _H Maximum Propagatin Delay from SCLR to Q _H Minimum Removal Time SCLR to SCK Minimum Setup Time from RCK to SCK	Conditio	ns Vcc 2.0V 4.5V 6.0V 4.5V 6.0V 6.0V 4.5V 6.0V 6.0V 6.0V 6.0V 6.0V 6.0V	T _A = Typ 10 45 50 62 20 18 65 20 18 65 20 18 65 20 28 66 20	25°C 6.0 30 35 175 35 30 175 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 205 41 35 30 30 32 35 30 35 30 35 30 35 35 35 30 35 35 35 30 35 35 35 35 35 35 35 35 35 35 35 35 35	T _A =-40 to Guarant 4.8 24 28 220 44 38 225 51 43 220 44 38 225 51 43 220 44 38 220 44 38 225 51 43 525 21 255 21 250 50 42	o 85°C T _A =-5 iteed Limits	is to 125°C 4.0 20 24 263 53 45 263 53 45 310 62 53 45 150 30 25 300 60 50	

Symbol	Parameter	Conditions	v _{cc}	$T_A = 25^{\circ}C$		T _A =-40 to 85°C	T _A =-55 to 125°C	Unite
Symbol	Farameter	Conditions	•cc	Тур		Guaranteed Li	mits	Units
t _S	Minimum Setup Time		2.0V		100	125	150	
	from Inputs A thru H		4.5V		20	25	30	ns
	to RCK		6.0V		17	21	25	
t _H	Minimum Hold Time		2.0V		0	0	0	
			4.5V		0	0	0	ns
			6.0V		0	0	0	
t _W	Minimum Pulse Width		2.0V	30	80	100	120	
	SCK, RCK, SCLR, SLOAD		4.5V	9	16	20	24	ns
			6.0V	8	14	18	20	
t _r , t _f	Maximum Input Rise and		2.0V		1000	1000	1000	
	Fall Time		4.5V		500	500	500	ns
			6.0V		400	400	400	
t _{THL} , t _{TLH}	Maximum Output		2.0V	30	75	95	110	
	Rise and Fall Time		4.5V	10	15	19	22	ns
			6.0V	8	13	16	19	
t _{THL} , t _{TLH}	Maximum Output		2.0V		75	95	110	ns
	Rise and Fall Time		4.5V		15	19	22	ns
			6.0V		13	16	19	ns
C _{PD}	Power Dissipation			07				
	Capacitance, Outputs (Note 6)			87				pF
CIN	Maximum Input			-	40	40	40	
	Capacitance			5	10	10	10	pF
C _{OUT}	Maximum Output			45	20	20	20	- F
	Capacitance			15	20	20	20	pF

MM74HC597

